FEATURES

- compatible with Serial Peripheral Interface (SPI)
- Supports SPI Modes 0 and 3
- 66MHz clock rate
- Block Write Protection
- Write Disable Instruction for Software Data Protection
- Secure WRITE
- Secure READ
- Hibernate Mode for low Standby Current
- Unlimited Read/Write Endurance
- Automatic Non-volatile STORE on Power Down
- Non-Volatile STORE under Instruction Control
- Automatic RECALL to SRAM on Power Up
- Unlimited RECALL Cycles
- 100k STORE Cycles
- 100-Year Non-volatile Data Retention
- Wide range 3.0V to 3.6V Power Supply
- Commercial and Industrial Temperatures
- 8-pin 150 mil SOIC and DFN Packages
- RoHS-Compliant

DESCRIPTION

The Anvo-Systems Dresden ANV32C91A is a 512kb serial SRAM with a non-volatile SONOS storage element included with each memory cell, organized as 64k words of 8 bits each. The devices are accessed by a high speed SPI-compatible bus. The ANV32C91A is

512kb Serial SPI nvSRAM

enabled through the Chip Enable pin (\overline{E}) and accessed via a 3-wire interface consisting of Serial Data Input (SI), Serial Data Output (SO) and Serial Clock (SCK). All programming cycles are self-timed, and no separate ERASE cycle is required before STORE.

The serial SRAM provides the fast access & cycle times, ease of use and unlimited read & write endurance of a normal SRAM. Dedicated safety features supporting high data accuracy.

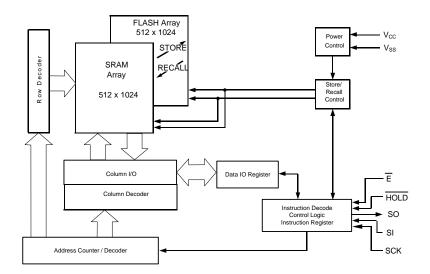
With Secure WRITE operation the ANV32C91A accepts address and data only when the correct 2 Byte CRC, generated from the 16 bit address and 64 Byte data, is transmitted. Corrupt data can not overwrite existing memory content and even valid data would not overwrite on a corrupted address. With status register bit 4 the success of the WRITE operation can be monitored. In case of corrupt data bit 4 will be set volatile to high. With Secure READ operation the ANV32C91A calculates the correct 2 Byte CRC parallel to data transfer. The 2 Byte CRC is transmitted after 64 Bytes of data have been transmitted.

Data transfers automatically to the non-volatile storage cells when power loss is detected or in any brown out situation (the PowerStore operation). On power up, data is automatically restored to the SRAM (the Power Up Recall operation).

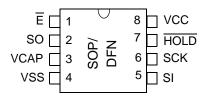
Both STORE and RECALL operations are also available under instruction control.

BLOCK WRITE Protection is enabled by programming the status register with one of four options to protect blocks.

BLOCK DIAGRAM



PIN CONFIGURATION



Top View

8-pin SOP 150 mil or DFN

PIN DESCRIPTIONS

Signal Name	Signal Description
Ē	Chip Enable
SCK	Serial Clock
SI	Serial Input
SO	Serial Output
HOLD	Hold (Suspends Serial Input)
VCC	Power Supply Voltage
VCAP	Capacitor Voltage
VSS	Ground

Serial Interface Description

Master: The device that generates the serial clock.

Slave: Because the Serial Clock pin (SCK) is always an input, the device always operates as a slave.

Transmitter/Receiver: The device has separate pins designated for data transmission (SO) and reception (SI).

Serial Output: The SO pin is used to transfer data serially out of the device. During a read cycle data is shifted out on this pin after the falling edge of the Serial Clock.

Serial Input: The SI pin is used to transfer data serially into the device. It receives instructions, addresses, and data. Data is latched on the rising edge of the Serial Clock.

Serial Clock: The SCK pin is used to synchronize the communication between a master and the device. Instructions, addresses, or data, present on the SI pin, are latched on the rising edge of the clock input, while data on the SO pin is changed after the falling edge of the clock input.

MSB: The Most Significant Bit (MSB) is the first bit transmitted and received.

Serial Op-Code: After the device is selected with \overline{E} going low, the first byte will be received. This byte contains the op-code that defines the operations to be performed.

Invalid Op-Code: If an invalid op-code is received, no data will be shifted into the device, and the serial output

pin (SO) will remain in a high impedance state until the falling edge of \overline{E} is detected. This will re-initialize the serial communication.

Chip Enable: The device is selected when the \overline{E} pin is low. When the device is not selected (\overline{E} pin is high), data will not be accepted via the SI pin, and the serial output pin (SO) will remain in a high impedance state. Unless an internal Write cycle is in progress the device will be in the Standby mode. Driving Chip Enable (\overline{E}) Low enables the device, placing it in the active power mode. After Power-up a falling edge on Chip Enable (\overline{E}) is required prior to the start of any instruction.

Write Protect: The main purpose of this input signal is to freeze the size of the area of memory that is protected against Write instructions (as specified by the values in the BP1 and BP0 bits of the Status Register) and the selected PowerStore mode. This pin must be driven either High or Low, and must be stable during all write operations. In case the Write Protect pin is not available the part cannot be hardware protected (internal high).

Hold: The HOLD pin is used in conjunction with the \overline{E} pin to select the device. When the device is selected and a serial sequence is underway, HOLD can be used to pause the serial communication with the master device without resetting the serial sequence.

Buffer Cap: The VCAP pin provides the necessary energy for the PowerStore operation, via an external capacitor.

Connecting to the SPI Bus

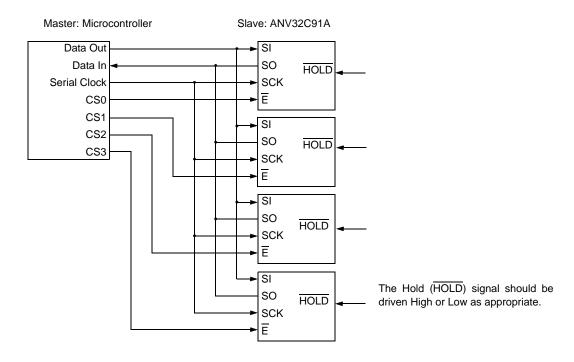
These devices are fully compatible with the SPI pro-

All instructions, addresses and input data bytes are shifted in to the device most significant bit first. The Serial Input (SI) is sampled on the first rising edge of the Serial Clock (SCK) after Chip Enable (\overline{E}) goes Low. All output data bytes are shifted out after any read instruction, most significant bit first. The Serial Output (SO) is latched on the first falling edge of the Serial

Clock (SCK) after the instruction (such as the Read from Memory Array, Secure Read and Read Status Register instructions) has been clocked into the device.

The Figure shows four devices, connected to an MCU, on an SPI bus. Only one device is selected at a time, so only one device drives the Serial Data Output (SO) line at a time, all the others being in high impedance.

SPI BUS CONNECTION



SPI Modes

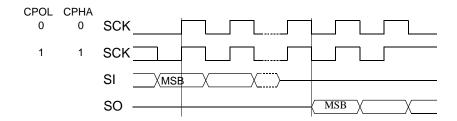
Each device can be driven by a microcontroller with its SPI peripheral running in either of the following two modes:

- Mode 0: CPOL=0, CPHA=0
- Mode 3: CPOL=1, CPHA=1

For these two modes, input data is latched in on the rising edge of Serial Clock (SCK), and output data is

available from the falling edge of Serial Clock (SCK). The difference between the two modes, as shown in the following figure, is the clock polarity when the bus master is in Stand-by mode and not transferring data:

- SCK remains at 0 for (CPOL=0, CPHA=0)
- SCK remains at 1 for (CPOL=1, CPHA=1)



Operating Features

Power up:

When the power supply is turned on from V_{SS} , Chip Enable (\overline{E}) has to follow the V_{CC} voltage in accordance with the definition of V_{IH} . It must not be allowed to float, but could be connected via a suitable pull-up resistor to V_{CC} .

The Chip Enable signal (\overline{E}) is edge as well as level sensitive. This ensures that the device becomes deselected after Power-down until \overline{E} reaches V_{CC} and a falling edge of \overline{E} from the V_{IH} level has been detected thereafter. This will start the first operation.

Power On Reset:

In order to prevent data corruption and inadvertent Write operations during Power-up, all input signals will be ignored and Serial Data Output (SO) will be in high impedance state. Power On Reset is exited when V_{CC} reaches a stable V_{CCmin} . Logical signals can applied.

Power-down / Brown Out: When V_{CC} drops during normal operation below V_{SWITCH} all external operations will be disabled, the device will ignore any input signals and Serial Data Output (SO) will be in high impedance state. Power-down during self timed Store Operation will not corrupt data in the memory. Write operation of the current Byte will be completed independent from the power supply. Prior to any Store operation the whole data in the non-volatile memory will be

Functional Description

The device utilizes an 8-bit instruction register. The list of instructions and their operation codes are contained in the following table. All instructions, addresses, and erased to allow Store operation of new and restore of unchanged data.

Operating and Stand-by Modes: When Chip Enable (E) is Low, the device is enabled. In Operating Mode it is consuming $I_{CC(OP)}$. In the other case, when Chip Enable (E) is High, the device is in Standby Mode with the reduced Supply Current $I_{CC(SB)}$.

Hold Condition: The Hold (HOLD) signal suspends any serial communication with the device without resetting the clock sequence.

Serial Data Out<u>put is</u> in high impedance state during Hold condition, HOLD=Low . The other SPI-inputs are disabled and Don't Care.

The device has to be active with Chip Enable (\overline{E}) Low to enter the Hold condition. The device has to be selected for the duration of the Hold condition, for the selected operation to be continued after exiting the Hold condition. The Hold condition starts when Hold (\overline{HOLD}) becomes Low, the device is active with Chip Enable (\overline{E}) Low and Serial Clock (SCK) is already Low. The Hold conditions ends when Hold (\overline{HOLD}) goes High, the device is still active with Chip Enable (\overline{E}) Low and Serial Clock (SCK) is Low.

Chip Enable (\overline{E}) has priority over Hold (\overline{HOLD}) . Driving Chip Enable (\overline{E}) High during Hold condition will reset the device. With the next falling edge of Chip Select (\overline{E}) a new instruction has to be submitted.

data are transferred with the MSB first and start with a high-to-low \overline{E} transition. Each instruction starts with one of the single-byte codes below.

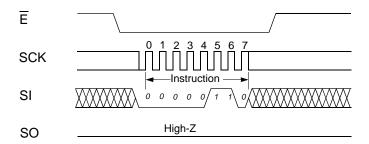
Instruction Name	Instruction format	Operation
WREN	0000 0110	Set Write Enable Latch
WRDI	0000 0100	Reset Write Enable Latch
RDSR	0000 0101	Read Status Register
WRSR	0000 0001	Write Status Register
READ	0000 0011	Read Data from Memory Array
SECURE READ	0001 0011	Secure Read Data from Memory Array with CRC
WRITE	0000 0010	Write Data to Memory Array
SECURE WRITE	0001 0010	Secure WRITE Data to Memory Array with CRC
STORE	0000 1000	Store SRAM data non-volatile
RECALL	0000 1001	Recall non-volatile data to SRAM
WRSNR	1100 0010	Write User Serial Number
RDSNR	1100 0011	Read User Serial Number
Hibernate	10111001	Enter Hibernate Mode

Write Enable (WREN):

The device will power-up in the write disable state when V_{CC} is applied. Before any WRITE instruction is accepted, the Write Enable Latch has to be set with the WREN command.

As shown in the figure below, to send this instruction to

the device, Chip Enable (\overline{E}) is driven Low, and the bits of the instruction byte are shifted in on Serial Data Input (SI). The device then enters a wait state, waiting for the device to be deselected, by Chip Enable (\overline{E}) being driven High.



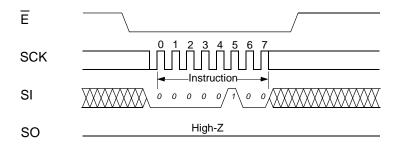
Write Disable (WRDI):

To protect the device against inadvertent writes, the Write Disable instruction disables all WRITE modes. The WRDI instruction is independent of the status of the WP pin.

As shown in the figure below, to send this instruction to the device, Chip Enable (\overline{E}) is driven Low and the bits of the instruction byte are shifted in, on Serial Data Input (SI). The device then enters a wait state, waiting for the device to be deselected, by Chip Enable (\overline{E}) being driven High.

The Write Enable Latch (WEN) bit can be reset by any of the following events:

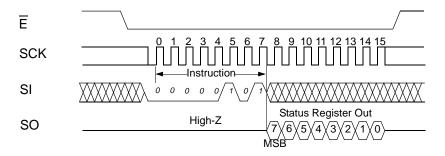
- Power-up
- WRDI instruction execution
- WRSR instruction completion
- WRITE instruction completion
- WRSNR instruction completion
- SECURE WRITE instruction completion



Read Status Register (RDSR):

The Read Status Register instruction provides access to the status register. The READY/BUSY, PowerStoreDisable (PDIS) and Write Enable status of the device can be determined by the RDSR instruction. Similarly, the Block Write Protection bits and WPEN indicate the

extent of protection employed. These bits, besides RDY and WEN, are set by using the WRSR instruction. The SWM bit will be automatically set as result of an corrupt volatile data transfer in Secure WRITE and can just be reset to zero by a successful SECURE WRITE.



Status Register content:

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	PDIS		SWM	BP1	BP0	WEN	RDY

Bit	non- volatile	Definition
Bit 0 (RDY)	no	The Ready bit indicates whether the memory is busy with a STORE or RECALL cycle. When set to 1, such a cycle is in progress, when reset to 0 no such cycle is in progress. It is a read only bit
Bit 1 (WEN)	no	The Write Enable Latch bit indicates the status of the internal Write Enable Latch. When set to 1 with a Write Enable (WREN) instruction the internal Write Enable Latch is set, when set to 0 with a Write Disable (WRDI) instruction the internal Write Enable Latch is reset and no Write, Secure Write, Write Serial Number or Write Status Register instruction are accepted.
Bit 2 (BP0)	yes	The Block Protect (BP1, BP0) bits are non-volatile. They define the size of the area to be software protected against Write instructions. These bits are written with the Write Status Register (WRSR) instruction. When one or both of the Block Protect (BP1, BP0) bits are set to 1, the relevant memory area (see Write Status Register WRSR) becomes
Bit 3 (BP1)	yes	protected against all Write (WRITE, Secure WRITE) instructions to the Memory Array. The Block Protect (BP1, BP0), Write Protect Enable (WPEN) and Power Store Disable (PDIS) bits can be written provided that the Hardware Protected Mode has not been set.
Bit 4 (SWM)	no	Secure WRITE Monitoring bit indicates the success of the last Secure Write operation. With SWM = 0 Secure Write was successful, with SWM = 1 data and/or address were corrupt. Secure Write was ignored. It is a read only bit.
Bit 5		don't care
Bit 6 (PDIS)	yes	The Power Store Disable bit disables the Power Store function
Bit 7	yes	has to be set to "0"

Write Status Register (WRSR):

The WRSR instruction allows the user to select Power-Store mode to be enabled or disabled as well as one of four levels of protection.

WREN command has to be sent prior to WRSR. The properties for access the Status Register are the same as the memory array. The WRSR instruction is volatile.

To make Bit2, Bit3, Bit6 and Bit7 non-volatile a STORE instruction has to follow the WRSR instruction. This STORE instruction is also valid for the memory array and all other non-volatile registers.

SWM is internally reset to 0 at the begin of each Secure WRITE operation.

The device is divided into several array segments. One quarter, one half, or all of the memory segments can be protected. Any data within any selected segment will therefore be READ only. The block write protection levels and corresponding status register control bits BP1 and BP2 are shown in the following table.

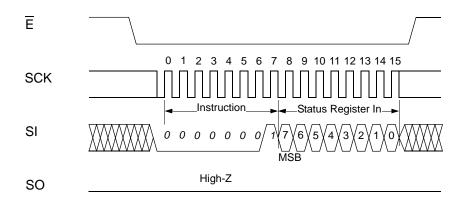
Level	Status Reg	gister Bits	Array Addresses Protected
(Protected Block)	BP1	BP0	ANV32C91A
0	0	0	None
1 (Upper quarter)	0	1	C000 - FFFF
2 (Upper half)	1	0	8000 - FFFF
3 (Whole memory)	1	1	0000 - FFFF

PDIS=1 disables the PowerStore feature and during power down all volatile data, in the memory array as well as the in the non-volatile registers, are lost.

The Write Status Register (WRSR) instruction has no effect on b4 (SWM), b1 (WEN) and b0 (RDY) of the

Status Register.

Chip Enable (E) must be driven High after the eighth bit of the data byte has been clocked in. If not, the Write Status Register (WRSR) instruction is not executed.



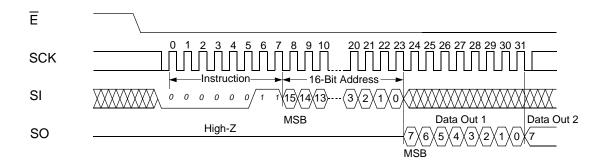
Read from Memory Array (READ):

Reading the device via the SO (Serial Output) pin requires the following sequence. After the \overline{E} is pulled low to select a device, the READ operation code is transmitted via SI followed by the byte address to be read (A15 - A0).

Upon completion, any data on SI will be ignored. The data (D7 - D0) at the specified address is then shifted out onto SO. If only one byte is to be read, \overline{E} should be driven high after the data comes out. The device is for

READ operation always in block roll over mode, so that the READ sequence can be continued, the byte address is automatically incremented and data will continue to be shifted out. When the highest address is reached, the address counter will roll over to the lowest address allowing the entire memory to be read in one continuous READ cycle.

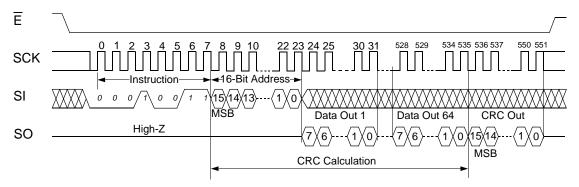
The Read cycle can be started when a WRITE or STORE cycle is not in progress and terminated at any time driving the Chip Enable (\overline{E}) to High.



Secure Read Memory Array (Secure READ):

The secure READ operation is a 64 Byte data read out of the memory array. In parallel with the data transfer to the external bus internally a CRC is calculated, including the start address and all 64 Byte data. After last byte is read the 16 bit CRC will be clocked out on SO. Only the actual 16 address bits are used for CRC

calculation. The unused address bit is not included in the CRC calculation. The CRC16-CCITT polynomial $x^{16}+x^{12}+x^5+1$ is used for calculation. Page roll over is defined for Secure READ. The initial value is 0xFFFF. The checksum is transmitted with MSB first.



Write to Memory Array (WRITE):

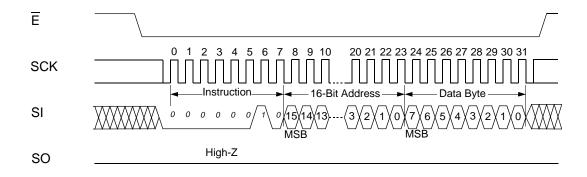
In order to write the device, two separate instructions must be executed. First, the device must be write enabled via the Write Enable (WREN) Instruction. Then a Write (WRITE) Instruction may be executed. Also, the address of the memory location(s) to be written must be outside the protected address field location, selected by the Block Write Protection Level.

A Write Instruction requires the following sequence. After \overline{E} is pulled low to select the device, the WRITE operation code is transmitted via SI followed by the byte address (A15 - A0) and the data (D7 - D0) to be written. Write to the SRAM will start after the \overline{E} pin is brought high. The Low-to-High transition of the \overline{E} pin must occur during the SCK low-time immediately after clocking in the D0 (LSB) data bit, if not, the WRITE operation will not be executed.

The part works in block roll over mode so that up to the whole memory array can be written with one command. After each byte of data is received, the address bits are internally incremented by one. All completely written bytes of an active page become valid when \overline{E} pin is brought high or a new page starts or any STORE is initiated. Only the last incomplete written byte will be ignored. Reaching the highest address the counter will roll over. This process can be continued until all data are written.

The device is automatically returned to the write disable state on completion of a WRITE cycle.

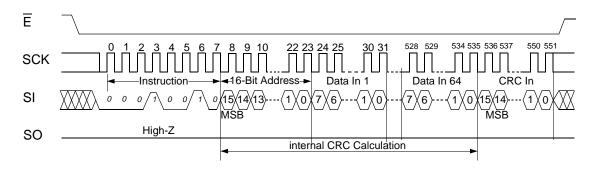
If the device is not Write enabled (WREN), the device will ignore the Write instruction and will return to the standby state, when \overline{E} is brought high. A new \overline{E} falling edge is required to re-initiate the serial communication.



Secure WRITE Memory Array (Secure WRITE):

To enable the Secure WRITE operation a WREN has to occur first. Secure WRITE is a 64 Byte data WRITE to the memory array. A CRC is calculated, in parallel with the data transfer, from the 16 bit address and 64 Byte data. After last byte is written the 16 bit CRC has to be clocked in on SI. The actual 16 address bits will be used for CRC calculation. The CRC16-CCITT polynomial used is $x^{16} + x^{12} + x^5 + 1$. Page roll over is defined for Secure WRITE. The initial value is 0xFFFF. The checksum must be transmitted with MSB first on SI. The Low-to-High transition of the \overline{E} pin must occur dur-

ing the SCK low-time immediately after clocking in the CRC0 (LSB) bit, if not, the WRITE operation will not be executed. In addition the internally calculated CRC has to match the transmitted CRC. In this case data will be accepted. If the CRC's don't match data will be ignored, the existing memory data will stay and Status Register bit 4 will be set to 1. With RDSR the success of Secure WRITE has to be checked after every Secure Write operation and bit 4 is reset to 0 at the begin of next Secure Write operation.



STORE

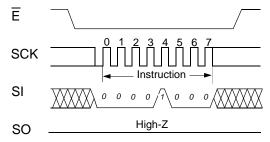
Data can be transferred from the SRAM to the non-volatile memory by a STORE command. During the STORE cycle, previous non-volatile data will be erased and then the new data stored into the non-volatile elements. Once a STORE cycle is initiated, further memory inputs and outputs are disabled until the cycle is completed. During a STORE operation, all commands will be ignored except the RDSR instruction.

In case no command will be sent after STORE cycle completion a new STORE cycle will be initiated with the rising edge of $\overline{\mathsf{E}}$

The READY/BUSY status of the device can be determined by initiating a Read Status Register (RDSR) Instruction.

After the $t_{\mbox{\scriptsize STORE}}$ cycle time has been fulfilled, the SRAM will again be activated for any READ or WRITE operations.

Instruction initiated STORE cycles are performed regardless of whether a WRITE operation has taken place after the last STORE or POWER-UP and is valid also for all non-volatile registers.



RECALL

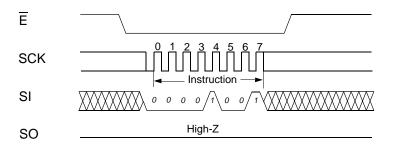
Data can be transferred from the non-volatile memory to the SRAM by a RECALL command.

Internally, RECALL is a two-step procedure. First, the SRAM data is cleared, and second, the non-volatile information is transferred into the SRAM cells. After the t_{RECALL} cycle time, the SRAM will be activated for any operations. The RECALL operation in no way alters the data in the non-volatile storage elements.

During an Recall operation, all commands will be ignored except the RDSR instruction.

In case no command will be sent after RECALL cycle completion a new RECALL cycle will be initiated with the rising edge of $\overline{\mathsf{E}}$.

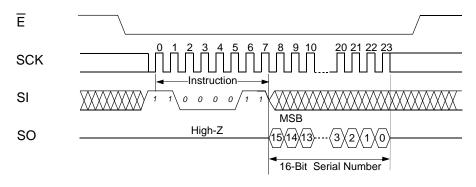
The READY/BUSY status of the device can be determined by initiating a Read Status Register (RDSR) Instruction.



Read User Serial Number (RDSNR)

Anv32C91 supports an additional non-volatile 16 byte register for a user-controlled serial number.

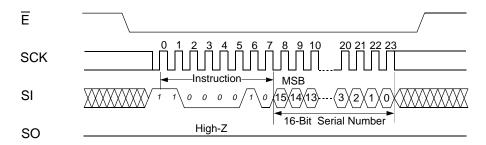
With RDSNR register content can be read out.



Write User Serial Number (WRSNR)

To enable the WRSNR operation a WREN has to occur first. With WRSNR a 16 byte user-controlled serial number can be written volatile to the register.

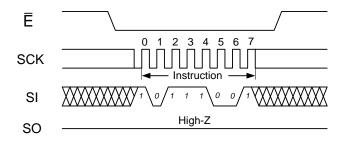
All 16 byte have to be clocked in otherwise the data will be ignored. With a STORE operation data in the register becomes non-volatile.



Hibernate Mode:

To enable the HIBERNATE mode the Hibernate command has to be transferred. After \overline{E} goes high the ANV32A91 will ignore any input signals until \overline{E} goes low again. During HIBERNATE mode the part will consume only the current I_{SBH} .

With the falling edge of \overline{E} an internal Power-up Recall cycle will be initiated and after this cycle is completed the device is ready for any operation.



PowerStore Operation:

PowerStore operation is a unique feature of the SONOS technology that is enabled by default on the ANV32C91A.

During normal operation, the device will draw current from V_{CC} for circuit operation and to charge a capacitor connected to the V_{CAP} pin. This stored charge will be used by the chip to perform a single STORE operation in case of power down. If the voltage on the V_{CC} pin drops below V_{SWITCH} , the part will automatically disconnect the V_{CAP} pin from V_{CC} . A STORE operation will be initiated with power provided by the V_{CAP} capacitor

In case of V_{CC} dropping below V_{SWITCH} during a normal WRITE only complete written bytes will be stored non-volatile with the new content. On the byte where WRITE is in progress all transferred bits will be ignored.

If a Secure WRITE operation is in progress when V_{CC} drops V_{SWITCH} the complete transferred data of this ongoing Secure WRITE operation becomes invalid.

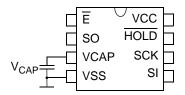
With the following Power Store execution these data become non-volatile.

Power Up Recall:

During power up or after any low-power condition ($V_{CC} < V_{SWITCH}$), an internal RECALL request will be latched. When V_{CC} once again exceeds the sense voltage of V_{SWITCH} , a RECALL cycle will automatically be initiated and will take $t_{HRECALL}$ to complete.

During Power Up Recall operation, all commands will

Below, is shown the proper connection of the storage capacitor (V_{CAP}) for automatic store operation. Refer to the DC CHARACTERISTICS table for the size of V_{CAP}



To reduce un-needed non-volatile stores, Power Store operation will be ignored unless at least one WRITE operation has taken place since the most recent STORE or RECALL cycle. The PowerStore Operation is valid for memory array and all non-volatile registers in parallel. The Read Status Register is disabled and no monitoring is possible when a Power Store cycle is in progress.

In this case the WP pin is available and the Hardware Protection mode can be executed, otherwise Hardware Protection is not applicable.

The PowerStore function can also be disabled by setting PDIS of status register to 1.

be ignored except the RDSR instruction. The READY/BUSY status of the device can be determined by initiating a Read Status Register (RDSR) Instruction.

If Bit 0 = 1, the Power UP Recall cycle is still in progress. If Bit 0 = 0, Power up Recall cycle has ended.

ANV32C91A

ABSOLUTE MAXIMUM RATINGS^a

Voltage on Input Relative to Ground	0.5V to 4.5V
Voltage on Input Relative to VSS0.6	V to (VCC + 0.5V)
Temperature under Bias	55°C to 125°C
Storage Temperature	65°C to 150°C
Power Dissipation	0.5W
DC Output Current (1 output at a time, 1s duration	n)15mA

Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Operating Conditions

Symbol	Parameter	ANV32	Unit	
Symbol	Farameter	Min.	Max.	Offic
V _{CC}	Operating Voltage	3.0	3.6	V

DC CHARACTERISTICS

 $(V_{CC} / V = 3.0 - 3.6)$

OVMDO:	DADAMETER	СОММ	ERCIAL	INDU	STRIAL	LINUTC	NOTES
SYMBOL	PARAMETER	MIN	MAX	MIN	MAX	UNITS	NOTES
I _{CC1} ^a	Average V _{CC} Current at 66MHz		5		5	mA	Byte READ to Byte WRITE ratio 1:1 $V_{IN} \le 0.2V_{CC}$ or $\ge 0.8V_{CC}$
I _{CC2} ^b	Average V _{CC} Current during STORE		2		2	mA	All Inputs Don't Care, V _{CC} = max
I _{CC3} ^a	Average V _{CC} Current at 10MHz		2		2	mA	Byte READ to Byte WRITE ratio 1:1, $V_{IN} \le 0.2 V_{CC}$ or $\ge 0.8 V_{CC}$
I _{SB1} ^c	Average V _{CC} Current Standby		400		400	μA	$\overline{E} \ge V_{IH}$, Cycling input levels
I _{SB2} ^c	V _{CC} Standby Current		300		300	μА	$\overline{E} \ge (V_{CC} - 0.2V)$ All Others $V_{IN} \le 0.2V$ or $\ge (V_{CC} - 0.2V)$
I _{SBH}	Hibernate Standby Current		3		3	μA	
I _{ILK}	Input Leakage Current		±1		±1	μА	V_{CC} = max V_{IN} = V_{SS} to V_{CC}
l _{OLK}	Off-State Output Leakage Current		±1		±1	μА	$V_{CC} = max$ $V_{IN} = V_{SS} \text{ to } V_{CC}, \overline{E} \ge V_{IH}$
V_{IH}	Input Logic "1" Voltage	0.8V _{CC}	V _{CC} + 0.5	0.8V _{CC}	V _{CC} + 0.5	V	All Inputs
V_{IL}	Input Logic "0" Voltage	V _{SS} - 0.5	0.2V _{CC}	V _{SS} - 0.5	0.2V _{CC}	V	All Inputs
V_{OH}	Output Logic "1" Voltage	V _{CC} -0.5		V _{CC} -0.5		V	I _{OUT} =- 0.4 mA
V _{OL}	Output Logic "0" Voltage		0.4		0.4	V	I _{OUT} = 2 mA
T _A	Operating Temperature	0	70	-40	85	°C	
V_{CAP}	Storage Capacitor	48	100	48	100	μF	6.3V
NV_C	non-volatile STORE operations	100		100		K	
DATA _R	Data Retention	100		100		Years	@55 °C

Note a: I_{CC_1} and I_{CC_3} are dependent on output loading and cycle rate. The specified values are obtained with outputs unloaded. Note b: I_{CC_2} is the average current required for the duration of the respective *STORE* cycles (t_{STORE}) . Note c: $E \ge V_{IH}$ will not produce standby current levels until any non-volatile cycle in progress has timed out.

Switching Characteristics	Syr	nbol				
Ownering Granacteristics	Alt.	IEC	Min.	Max.	Unit	
SCK Clock Frequency	f _{SCK}	f _C	0	66	MHz	
Chip Enable Setup Time	t _{CSS}	t _{su(E)}	6		ns	
/E High Time	t _{CS}	t ₂	7		ns	
/E Hold Time	t _{CSH}	t _{h(E)}	6		ns	
Clock Setup time	t _{SKSH}	t _{su(C)}	3		ns	
Clock High Time ^d	t _{CLH}	t ₅	7		ns	
Clock Low Time ^d	t _{CLL}	t ₆	7		ns	
Clock Rise Time	t _{RC}	t ₇		100	ns	
Clock Fall Time	t _{FC}	t ₈		100	ns	
Input Rise Time	t _{RD}			100	ns	
Input Fall Time	t _{FD}			100	ns	
Data Setup Time	t _{DSU}	t _{su(D)}	4		ns	
Data Hold Time	t _{DH}	t _{h(D)}	4		ns	
/HOLD Hold Time	t _{HH}	t _{h(H)}	5		ns	
/HOLD Setup Time	t _{HSU}	t _{su(H)}	0		ns	
Output Disable Time	t _{DIS}	t _{dis(E)}		20	ns	
Clock Low to Output Valid	t _V	t _{en(C)}		10	ns	
Output Hold Time	t _{HO}	t _{h(D)}	0		ns	
/HOLD High to Output Low-Z	t _{LZ}	t _{en(H)}		10	ns	
/HOLD Low to Output High-Z	t _{HZ}	t _{dis(H)}		10	ns	

 $^{^{}e}$ t_{CH} + t_{CL} \geq 1 / f_{SCK}

AC TEST CONDITIONS

Input Pulse Levels
Input Rise and Fall Times ≤ 5ns
Input and Output Timing Reference Levels 1.5V
Output Load

CAPACITANCE^d $(T_A = 25^{\circ}C, f = 1.0MHz)$

SYMBOL	SYMBOL PARAMETER		UNITS	CONDITIONS
C _{IN}	Input Capacitance	5	pF	$\Delta V = 0$ to 3.3V
C _{OUT}	Output Capacitance	7	pF	$\Delta V = 0$ to 3.3V

Note d: These parameters are guaranteed but not tested.

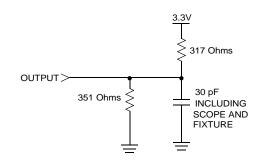


Figure 1. AC Output Loading

ANV32C91A

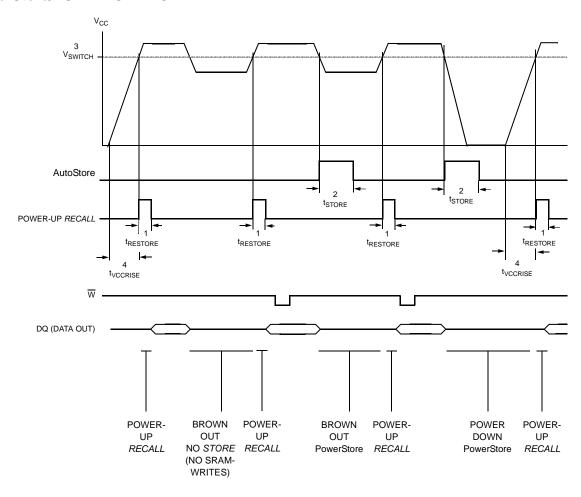
PowerStore/POWER-UP RECALL

NO.	SYM	BOLS	DADAMETED	ANV32C91A		UNITS	NOTES
NO. PARAMETER Standard Alternate	PARAMETER	MIN	MAX	UNITS	NOTES		
1	t _{RESTORE}		Power-up RECALL Duration		200	μS	е
2	t _{STORE}		STORE Cycle Duration		8	ms	
3	V _{SWITCH}		Low Voltage Trigger Level	2.35	2.65	V	
4	tvccrise		V _{CC} rise time	100		μs	
5	t _{RECALL}		RECALL Duration (normal operating conditions)		50	μs	f

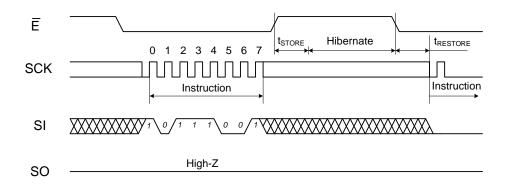
 $t_{\mbox{\scriptsize RESTORE}}$ starts from the time $V_{\mbox{\scriptsize CC}}$ rises above $V_{\mbox{\scriptsize SWIRTCH-}}$ VCC > VCCmin

Note f:

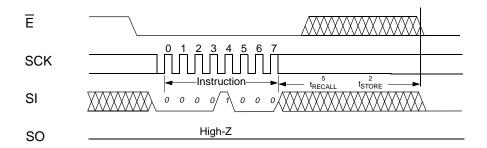
PowerStore/POWER-UP RECALL



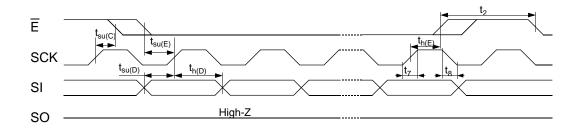
Hibernate



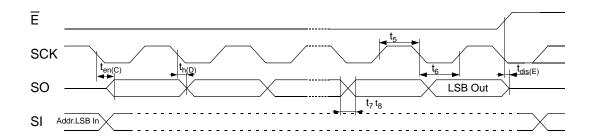
STORE/RECALL CYCLE (V_{CC} > V_{CCmin})



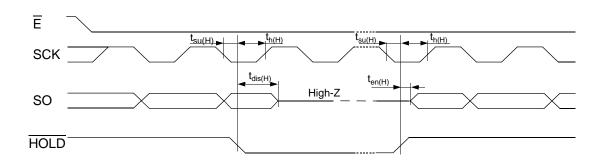
Serial Input Timing



Serial Output Timing



Hold Timing



Product Versions

The ANV32C91A will be available with the feature sets:

- Supply voltage range 3.0 to 3.6V

Initial Delivery State

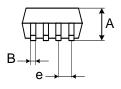
The device is delivered with Status Register 00x00xx, non-volatile memory array and User Serial Number "0".

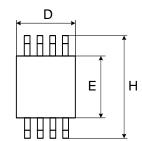
NOISE CONSIDERATIONS

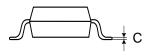
The ANV32C91A is a high-speed memory and so must have a high-frequency bypass capacitor of approximately $0.1\mu F$ connected between V_{CC} and V_{SS} , using leads and traces that are as short as possible. As with all high-speed CMOS ICs, normal careful routing of power, ground and signals will help prevent noise problems.

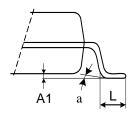
Packages

8-pin 150mil SOIC



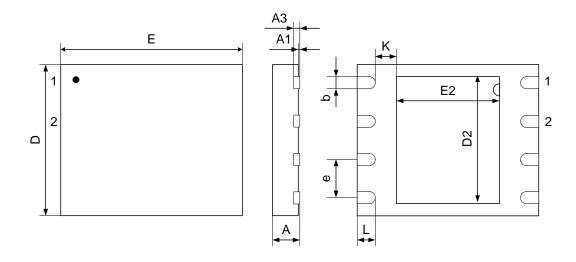






Symbol	mm			inches		
	typ	min.	max	typ.	min.	max.
А		1.35	1.75		0.053	0.069
A1		0.1	0.25		0.004	0.010
В		0.33	0.51		0.013	0.020
С		0.19	0.25		0.007	0.010
D		4.80	5.00		0.189	0.197
E		3.80	4.00		0.150	0.157
е	1.27			0.050		
Н		5.80	6.20		0.228	0.244
L		0.40	0.90		0.016	0.035
α		0°	8°		0°	8°

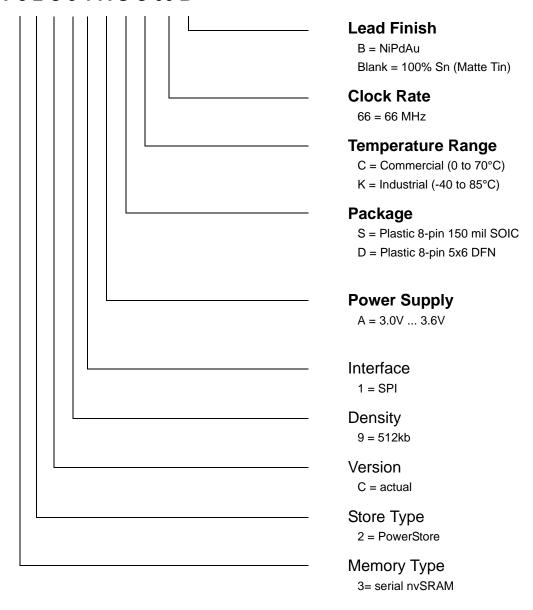
8-pin 5x6 DFN



Symbol	mm			inches		
	typ.	min.	max	typ.	min.	max.
Α	0.85	0.8	0.9	0.0335	0.0315	0.0354
A1	0.02	0.00	0.05	0.0008	0.0000	0.0020
A2	0.20			0.0079		
А3		0,20			0.0079	
b	0.40	0.35	0.45	00157	0.0138	0.0177
D	5.00			0.1969		
D2	4.20	4.10	4.30	0.1654	0.1614	0.1693
E	6.00			0.2362		
E2	3.40	3.30	3.50	0.1339	0.1299	0.1378
е	1.27			0.0500		
L	0.45	0.50	0.55	0.0177	0.0197	0.0217

Ordering Information

ANV 3 2 C 9 1 A S C 66 B



Document Revision History

Revision	Date	Summary
1.0	September 2018	initial version

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Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«**FORSTAR**» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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